

S3A - S3M



3.0 AMPS. Surface Mount Rectifiers SMC/DO-214AB



Features

- ♦ For surface mounted application
- ♦ Glass passivated junction chip.
- ♦ Low forward voltage drop
- ♦ High current capability
- ♦ Easy pick and place
- High surge current capability
- ♦ Plastic material used carries Underwriters Laboratory Classification 94V-0
- High temperature soldering:
- ♦ 260°C / 10 seconds at terminals
- → High reliability grade (AEC Q101 qualified)

Mechanical Data

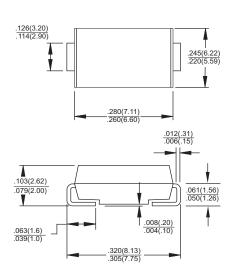
♦ Case: Molded plastic

♦ Terminals: Pure tin plated, lead free.

♦ Polarity: Indicated by cathode band

♦ Packaging: 16mm tape per EIA STD RS-481

♦ Weight: 0.21 gram



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	S3A	S3B	S3D	S3G	S3J	S3K	S3M	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @T _L =105 °C	I _(AV)	3.0							Α
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	100							А
Maximum Instantaneous Forward Voltage @ 3.0A	V _F	1.15							V
Maximum DC Reverse Current @ T _A =25 °C at Rated DC Blocking Voltage @ T _A =125 °C	I _R	10.0 250							uA uA
Typical Reverse Recovery Time (Note 1)	Trr	1.5							uS
Typical Junction Capacitance (Note 2)	Cj	60							pF
Typical Thermal Resistance (Note 3)	R _{θJL} R _{θJA}	13 47							°C/W
Operating Temperature Range	TJ	-55 to +150							°C
Storage Temperature Range	Тѕтѕ	-55 to +150							°C

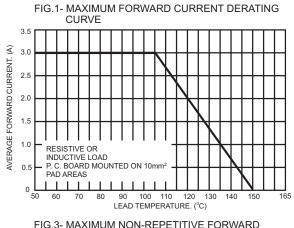
Notes:

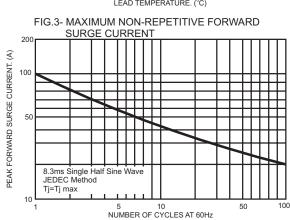
- 1. Reverse Recovery Test Conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A
- 2. Measured at 1 MHz and Applied V_R=4.0 Volts
- 3. Measured on P.C. Board with 0.6" x 0.6" (16mm x 16mm) Copper Pad Areas.

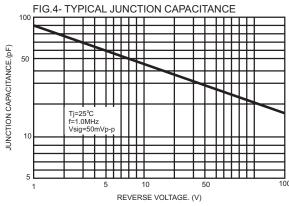
Version: D08

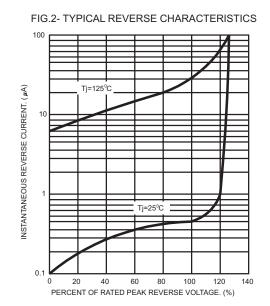


RATINGS AND CHARACTERISTIC CURVES (S3A THRU S3M)









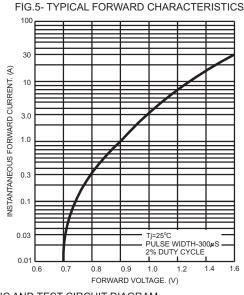
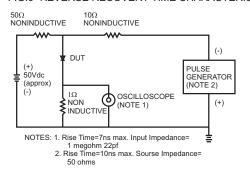
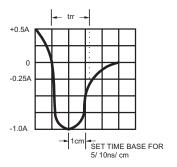


FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





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